



# EDCON-COMPONENTS



Designed for surface mounting on high density circuit board

Emboss carrier tape packing systems is available for automatic insertion



## Technical Informations

|  |                     |
|--|---------------------|
| Voltage:                                 | <b>63Volt</b>       |
| Range:                                   | <b>330µF</b>        |
| Dimension; D x L mm                      | <b>12,5x16mm</b>    |
| Impedance (Ω) max., at20°C, 100kHz       | <b>no specified</b> |
| Ripple Current (mA rms) at 105°C, 100kHz | <b>510mA</b>        |

| Ordering Code |                |           |          |
|---------------|----------------|-----------|----------|
| <b>630</b>    | <b>Voltage</b> |           |          |
| <b>331</b>    | <b>Range</b>   |           |          |
| <b>D=</b>     | <b>I</b>       | <b>L=</b> | <b>6</b> |

Operating Temperatur Range of -40°C ~ +85°C

Load Life of 1000~2000 hours at 85°C

|   |                      |  |      |      |      |      |      |      |      |      |      |
|---|----------------------|--|------|------|------|------|------|------|------|------|------|
| <b>Leakage current max.</b>                     | Ø4 ~ Ø10mm           | I= 0,01CV or 3µA whichever is greater ( after 2 minutes) |      |      |      |      |      |      |      |      |      |
|   | Ø12,5 ~ Ø16mm        | I= 0,03CV or 4µA whichever is greater ( after 1 minutes) |      |      |      |      |      |      |      |      |      |
| <b>Capacitance tolerance</b>                    | ± 20% at 120Hz, 20°C |  |      |      |      |      |      |      |      |      |      |
| <b>Dissipation factor max. (at 120Hz, 20°C)</b> | WV                   |  | 4,0  | 6,3  | 10   | 16   | 25   | 35   | 50   | 63   | 100  |
|   | Tanδ                 | Ø4 ~ Ø10mm   | 0,42 | 0,30 | 0,26 | 0,22 | 0,16 | 0,14 | 0,21 | 0,12 | 0,12 |
|   |                      | Ø12,5 ~ Ø16mm  | 0,45 | 0,38 | 0,34 | 0,30 | 0,26 | 0,22 | 0,18 | 0,14 | 0,12 |

|  |               |                 |     |     |    |    |    |    |    |    |     |
|--|---------------|-----------------|-----|-----|----|----|----|----|----|----|-----|
| <b>Low Temperatur characteristics ( Impedance ratio at 120Hz )</b> | WV            |                 | 4,0 | 6,3 | 10 | 16 | 25 | 35 | 50 | 63 | 100 |
|  | Ø4 ~ Ø10mm    | Z-25°C / Z+20°C | 7   | 4   | 3  | 2  | 2  | 2  | 2  | 2  | 2   |
|  |               | Z-40°C / Z+20°C | 15  | 8   | 6  | 4  | 4  | 3  | 3  | 3  | 4   |
|  | Ø12,5 ~ Ø16mm | Z-25°C / Z+20°C | 7   | 5   | 4  | 3  | 2  | 2  | 2  | 2  | 2   |
| Z-40°C / Z+20°C  |               | 17              | 12  | 10  | 8  | 5  | 4  | 3  | 3  | 3  |     |

|  |  |  |  |  |  |  |  |  |  |  |  |
|--|--|--|--|--|--|--|--|--|--|--|--|
| <b>Load Life ( after application of the rated voltage for 1000hrs at 105°C</b> | Leakage current  | Less than specified value                  |  |  |  |  |  |  |  |  |  |
|  | Capacitance Change   | Within ±20% of initial value               |  |  |  |  |  |  |  |  |  |
|  |  | Within ±30% of initial value for 4V & 6,3V |  |  |  |  |  |  |  |  |  |
|  | Tanδ   | Less than 200% of specified value          |  |  |  |  |  |  |  |  |  |
| <b>Shell life (at 85°C)</b>  | Ø4 ~ , Ø6,3x5,4: 1000hours   |  |  |  |  |  |  |  |  |  |  |
|  | After 1000hours no load test, leakage current, capacitance and tanδ are same as load life value. |  |  |  |  |  |  |  |  |  |  |

**CHIP Wide Temperature Range 105°C**

Part No.: **I15005**

|       |        |      |        |        |        |           |           |      |            |
|-------|--------|------|--------|--------|--------|-----------|-----------|------|------------|
| DRW:  | Jason  | CHKD | Wilson | MATL:  | Wilson | TOLERANCE | Mason     | DATE | 03.06.2014 |
| APPD: | Schumi |      |        | FINISH | Jamy   |           | Sheet No. |      | 2 from 7   |

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|                                     |   |                                    |
|-------------------------------------|---|------------------------------------|
| <b>Resistance to soldering heat</b> | After reflow soldering and resistance at room temperature, they meet the characteristics requirements listed at underside |                                    |
|                                     | Leakage current   | Less than specified value          |
|                                     | Capacitance Change  | Within $\pm 10\%$ of initial value |
|                                     | Tan $\delta$  | Less than specified value          |

| FREQUENCY COEFFICIENT OF PERMISSIBLE RIPPLE CURRENT |               |           |       |       |      |              |
|---|---------------|-----------|-------|-------|------|--------------|
| Diameter  | Capacitance   | Frequency |       |       |      |              |
|   | $\mu\text{F}$ | 50Hz      | 120Hz | 300Hz | 1KHz | 10KHz $\leq$ |
| $\varnothing 4 \sim \varnothing 10\text{mm}$        | 0,1 ~68       | 0,70      | 1,00  | 1,17  | 1,36 | 1,50         |
|   | 100 ~3300     | 0,85      | 1,00  | 1,08  | 1,20 | 1,30         |
| $\varnothing 12,5 \sim \varnothing 16\text{mm}$     | ~68           | 0,75      | 1,00  | 1,35  | 1,57 | 2,00         |
|   | 100 ~680      | 0,80      | 1,00  | 1,23  | 1,34 | 1,50         |
|   | 1000 ~6800    | 0,85      | 1,00  | 1,10  | 1,13 | 1,15         |

|  |               |
|--|---------------|
| <b>CHIP Wide Temperature<br/>Range 105°C</b> |               |
| Part No.:                                    | <b>I15005</b> |
| Customer:                                    |               |

|       |        |      |        |        |        |           |           |      |            |
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## Technical Drawing

### Dimension of Size $\varnothing 8 \times 10,5 \sim 16 \text{mm}$



### Dimension of Size $\varnothing 4 \sim 8 \times 6,2 \text{mm}$



| D x L    | $\varnothing 4 \times 5,4$ | $\varnothing 5 \times 5,4$ | $\varnothing 6,3 \times 5,4$ | $\varnothing 6,3 \times 7,7$ | $\varnothing 8 \times 6,2$ | $\varnothing 8 \times 10,5$ | $\varnothing 10 \times 10,5$ | $\varnothing 10 \times 13,5$ | $\varnothing 12,5 \times 13,5$ | $\varnothing 12,5 \times 16$ | $\varnothing 16 \times 16,5$ |
|----------|----------------------------|----------------------------|------------------------------|------------------------------|----------------------------|-----------------------------|------------------------------|------------------------------|--------------------------------|------------------------------|------------------------------|
| A        | 1,8                        | 2,1                        | 2,4                          | 2,4                          | 3,3                        | 2,9                         | 3,2                          | 3,2                          | 4,7                            | 4,7                          | 5,5                          |
| B        | 4,3                        | 5,3                        | 6,6                          | 6,6                          | 8,3                        | 8,3                         | 10,3                         | 10,3                         | 12,8                           | 12,8                         | 16,3                         |
| C        | 4,3                        | 5,3                        | 6,6                          | 6,6                          | 8,3                        | 8,3                         | 10,3                         | 10,3                         | 12,8                           | 12,8                         | 16,3                         |
| E +/-0.2 | 1,0                        | 1,3                        | 2,2                          | 2,2                          | 2,2                        | 3,1                         | 4,4                          | 4,4                          | 4,4                            | 4,4                          | 6,7                          |
| L        | 5,4                        | 5,4                        | 5,4                          | 7,7                          | 6,2                        | 10,5                        | 10,5                         | 13,5                         | 13,5                           | 16,0                         | 16,5                         |

\*1 Voltage mark (6V) represents 6,3V for  $\varnothing 4 \sim 10 \text{mm}$

\*3 (L +/- 0.5) is applicable to  $\varnothing 8 \times 10,5 \sim \varnothing 10 \text{mm}$

\*2 (L +/- 0.3) is applicable to  $\varnothing 6,3 \sim 7.7$  and  $\varnothing 8 + 6,2 \text{mm}$

\*4 (L +/- 1.0) is applicable to  $\varnothing 12,5 \sim \varnothing 16 \text{mm}$

RE. Date code and seriew type -1st digit for Year 2nd digit for Quarter, 4 quarter codes in one year area 1,4,7,0  
 3rd character for Serie S

**CHIP Wide Temperature  
 Range 105°C**

Part No.: **I15005**

|       |        |      |        |        |        |           |           |      |            |
|-------|--------|------|--------|--------|--------|-----------|-----------|------|------------|
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## Ordering Informations

| Serie | Voltage Code | Tolerance Code | Range Code | Size Code D | Size Code L | Special function | ROHS | Packing Code |  |  |
|-------|--------------|----------------|------------|-------------|-------------|------------------|------|--------------|--|--|
|-------|--------------|----------------|------------|-------------|-------------|------------------|------|--------------|--|--|

|               |            |          |            |          |          |           |          |           |  |  |
|---------------|------------|----------|------------|----------|----------|-----------|----------|-----------|--|--|
| <b>I15005</b> | <b>630</b> | <b>M</b> | <b>331</b> | <b>I</b> | <b>6</b> | <b>XX</b> | <b>R</b> | <b>TR</b> |  |  |
|---------------|------------|----------|------------|----------|----------|-----------|----------|-----------|--|--|

|                         |                |                     |                   |                   |                        |  |  |  |  |
|-------------------------|----------------|---------------------|-------------------|-------------------|------------------------|--|--|--|--|
| look table Voltage Code | <b>M= ±20%</b> | Ordering Code Range | Look table Code D | Look table Code L | <b>XX= No function</b> | <b>R= ROHS Conform</b><br><b>N= NON ROHS Conform</b> | <b>TR= Tape Reel Packing</b><br><b>BU= Bulk-Ware</b> |  |  |
|-------------------------|----------------|---------------------|-------------------|-------------------|------------------------|--|--|--|--|

|  |               |
|--|---------------|
| <b>CHIP Wide Temperature Range 105°C</b> |               |
| Part No.:                                | <b>I15005</b> |
| Customer:                                |               |

|       |        |      |        |        |        |           |           |      |            |
|-------|--------|------|--------|--------|--------|-----------|-----------|------|------------|
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## Soldering Profile Curve

### Classification Reflow Profile (JEDEC J-STD-020C)



|  |               |
|--|---------------|
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| Customer:                                |               |

|       |        |       |        |         |        |            |           |       |            |
|-------|--------|-------|--------|---------|--------|------------|-----------|-------|------------|
| DRW:  | Jason  | CHKD: | Wilson | MATL:   | Wilson | TOLERANCE: | Mason     | DATE: | 03.06.2014 |
| APPD: | Schumi |       |        | FINISH: | Jamy   |            | Sheet No. |       | 7 from 7   |